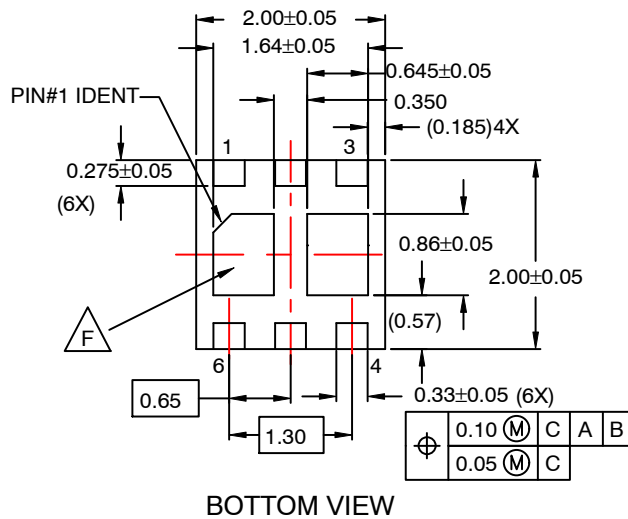
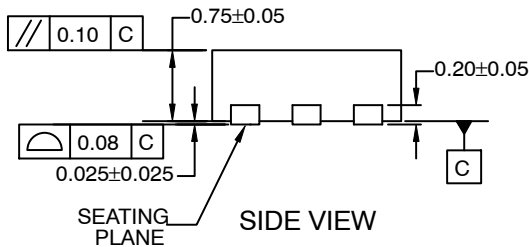
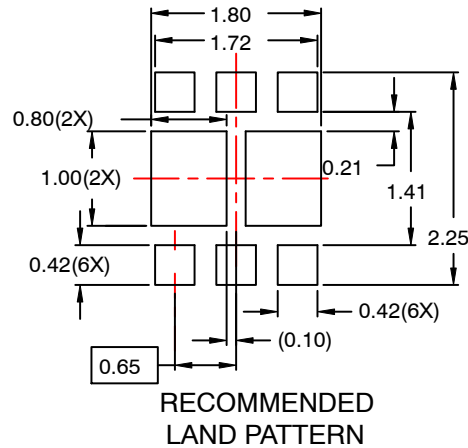
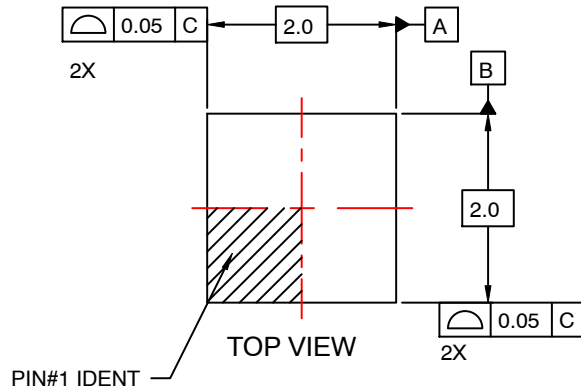


**WDFN6 2x2, 0.65P**  
**CASE 511DA**  
**ISSUE O**

DATE 31 JUL 2016



**NOTES:**

- CONFORM TO JEDEC REGISTRATIONS MO-229, VARIATION VCCC, EXCEPT WHERE NOTED.
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.

**F** NON-JEDEC DUAL DAP

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